

ON Semiconductor® FCB20N60-F085

N-Channel MOSFET 600V, 20A, 198mΩ

Features

- Typ $r_{DS(on)}$ = 173m Ω at V_{GS} = 10V, I_D = 20A
- Typ Q_{q(tot)} = 72nC at V_{GS} = 10V, I_D = 20A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

Description

SuperFETTM is ON Semiconductor's proprietary new generation of high voltage MOSFETs utilizing an advanced charge balance mechanism for outstanding low on-resistance and

lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET is suitable for various automotive DC/DC power conversion.

Applications

- Automotive On Board Charger
- Automotive DC/DC converter for HEV

MOSFET Maximum Ratings T_J = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain to Source Voltage		600	V
V _{GS}	Gate to Source Voltage		±30	V
I _D	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C =25°C	20	Α
	Pulsed Drain Current	T _C = 25°C	See Figure4	A
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	480	mJ
Р	Power Dissipation		341	W
P _D	Derate above 25°C		2.3	W/ºC
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 150	°C
$R_{ ext{ heta}JC}$	Thermal Resistance Junction to Case		0.44	°C/W
R_{\thetaJA}	Maximum Thermal Resistance Junction to Ambient	(Note 3)	43	°C/W

Package Marking and Ordering Information

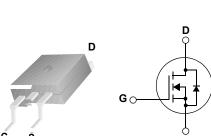
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCB20N60	FCB20N60-F085	TO-263AB	330mm	24mm	800 units

Notes:

1: Current is limited by bondwire configuration.

2: Starting $T_J = 25^{\circ}$ C, L = 15mH, $I_{AS} = 8$ A, $V_{DD} = 100$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche

3: $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta JA}$ is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.





Symbol	Parameter	Test	Conditions	Min	Тур	Max	Units
Off Cha	racteristics						
B _{VDSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V	/ _{GS} = 0V	600	-	-	V
	Drain to Source Leekage Current	V _{DS} =600V,	T _J = 25 ^o C	-	-	1	μA
DSS	Drain to Source Leakage Current	$V_{GS} = 0V$	$T_J = 150^{\circ}C(Note 4)$	-	-	1	mA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 30V$	·	-	-	±100	nA
	_	I _D = 20A,	$T_J = 25^{\circ}C$	-	173	198	mΩ
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _E	₀ = 250μA	3.0	4.0	5.0	V
DS(on)	Drain to Source On Resistance	$V_{GS} = 10V$	$T_{.1} = 150^{\circ}C(Note 4)$	_	471	570	mΩ
ynami	ic Characteristics			_	2710	3080	pF
C _{oss}	Output Capacitance	──V _{DS} = 25V, V f = 1MHz	_{GS} = 0V,	-	1350	1665	pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		-	86	150	pF
R _g	Gate Resistance	f = 1MHz		-	1	-	Ω
ג ק _(ToT)	Total Gate Charge at 10V	$V_{GS} = 0$ to 10	V V _{DD} = 300V	-	72	102	nC
Q _{g(th)}	Threshold Gate Charge	$V_{GS} = 0$ to $2V$	/ I _D = 20A	-	5	8.6	nC
Q _{gs}	Gate to Source Gate Charge		_	-	15	-	nC
<u>^</u>	Cata ta Drain "Miller" Charge		E CONTRACTOR E C		24	1	20

Switching Characteristics

t _{on}	Turn-On Time		-	-	166	ns
t _{d(on)}	Turn-On Delay Time		-	44	-	ns
t _r	Rise Time	V _{DD} = 300V, I _D = 20A, V _{GS} = 10V, R _G = 25Ω	-	60	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10V, R _G = 25Ω	-	208	-	ns
t _f	Fall Time		-	43	-	ns
t _{off}	Turn-Off Time		-	-	400	ns

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nC

Drain-Source Diode Characteristics

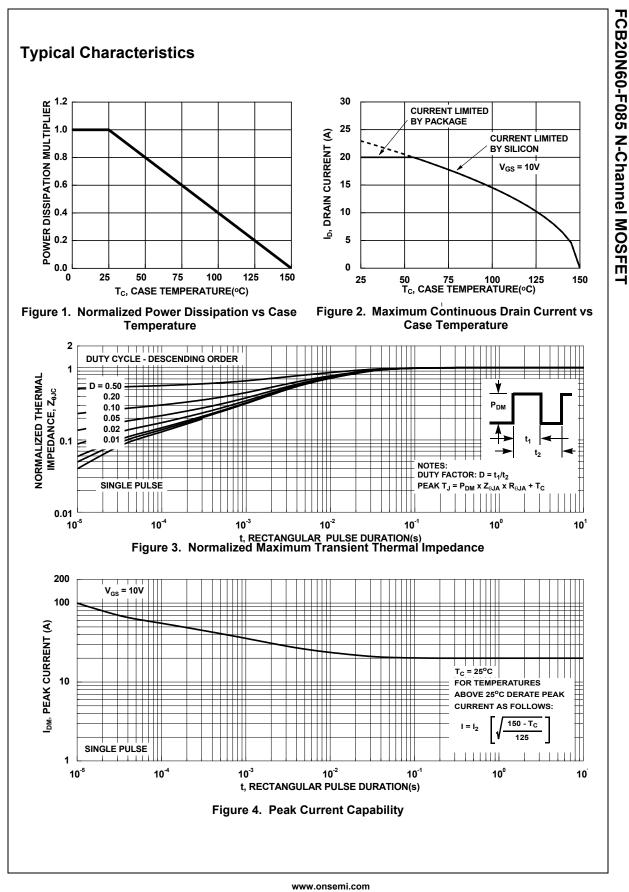
Gate to Drain "Miller" Charge

V_{SD}	Source to Drain Diode Voltage	I _{SD} = 20A, V _{GS} = 0V	-	-	1.4	V
T _{rr}	Reverse Recovery Time	I _F = 20A, dI _{SD} /dt = 100A/μs,	-	486	632	ns
Q _{rr}	Reverse Recovery Charge	V _{DD} =480V	-	10	13	μC

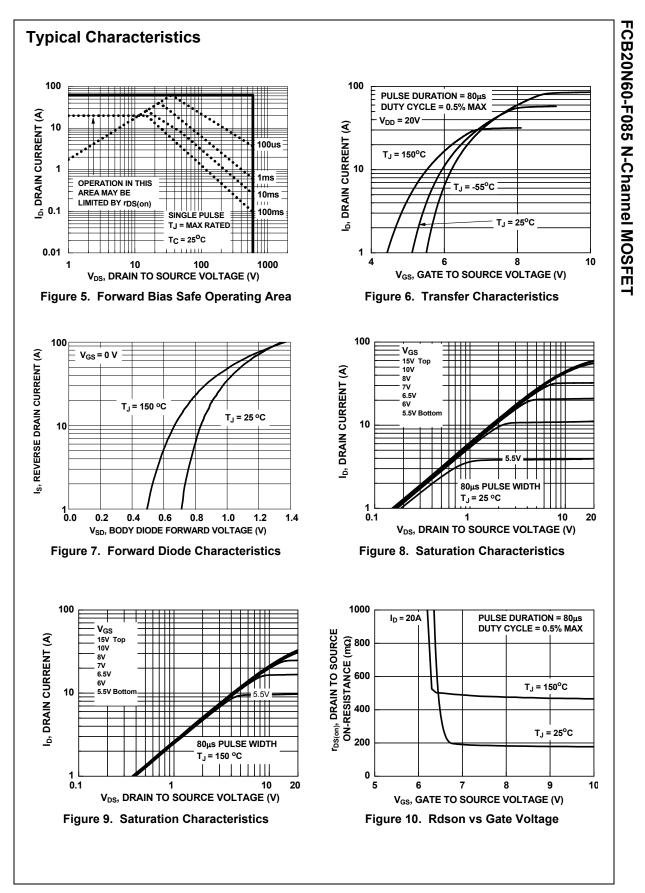
Notes:

Q_{gd}

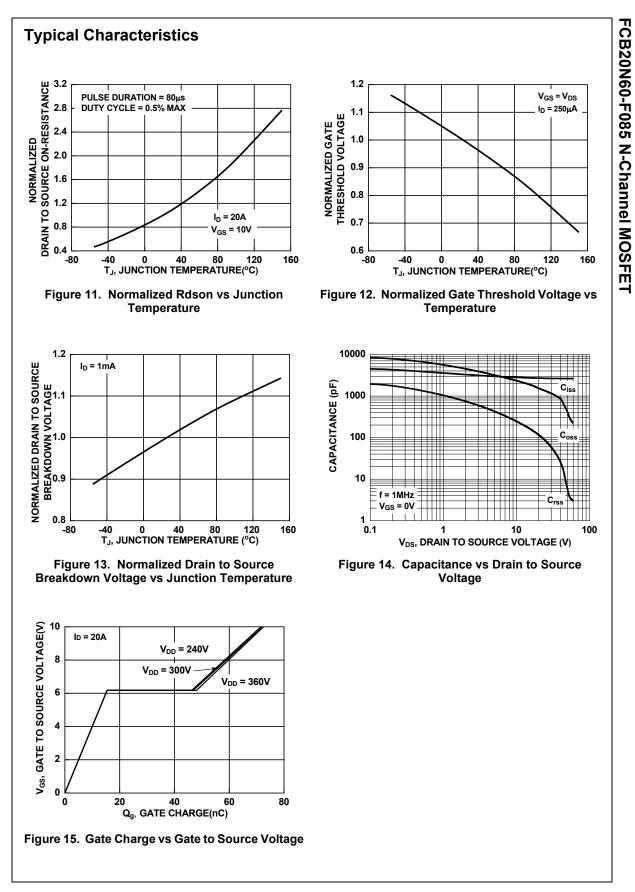
4: The maximum value is specified by design at T_J = 150°C. Product is not tested to this condition in production.



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